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#### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

#### Applications of "[Embedded - Microcontrollers](#)"

##### Details

Product Status	Active
Core Processor	AVR
Core Size	8/16-Bit
Speed	32MHz
Connectivity	I <sup>2</sup> C, IrDA, SPI, UART/USART, USB
Peripherals	Brown-out Detect/Reset, DMA, POR, PWM, WDT
Number of I/O	34
Program Memory Size	32KB (16K x 16)
Program Memory Type	FLASH
EEPROM Size	1K x 8
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	1.6V ~ 3.6V
Data Converters	A/D 12x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	0°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	44-VQFN Exposed Pad
Supplier Device Package	44-VQFN (7x7)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/atxmega32a4u-mnr">https://www.e-xfl.com/product-detail/microchip-technology/atxmega32a4u-mnr</a>

## 10. System Clock and Clock options

### 10.1 Features

- Fast start-up time
- Safe run-time clock switching
- Internal oscillators:
  - 32MHz run-time calibrated and tuneable oscillator
  - 2MHz run-time calibrated oscillator
  - 32.768kHz calibrated oscillator
  - 32kHz ultra low power (ULP) oscillator with 1kHz output
- External clock options
  - 0.4MHz - 16MHz crystal oscillator
  - 32.768kHz crystal oscillator
  - External clock
- PLL with 20MHz - 128MHz output frequency
  - Internal and external clock options and 1x to 31x multiplication
  - Lock detector
- Clock prescalers with 1x to 2048x division
- Fast peripheral clocks running at two and four times the CPU clock
- Automatic run-time calibration of internal oscillators
- External oscillator and PLL lock failure detection with optional non-maskable interrupt

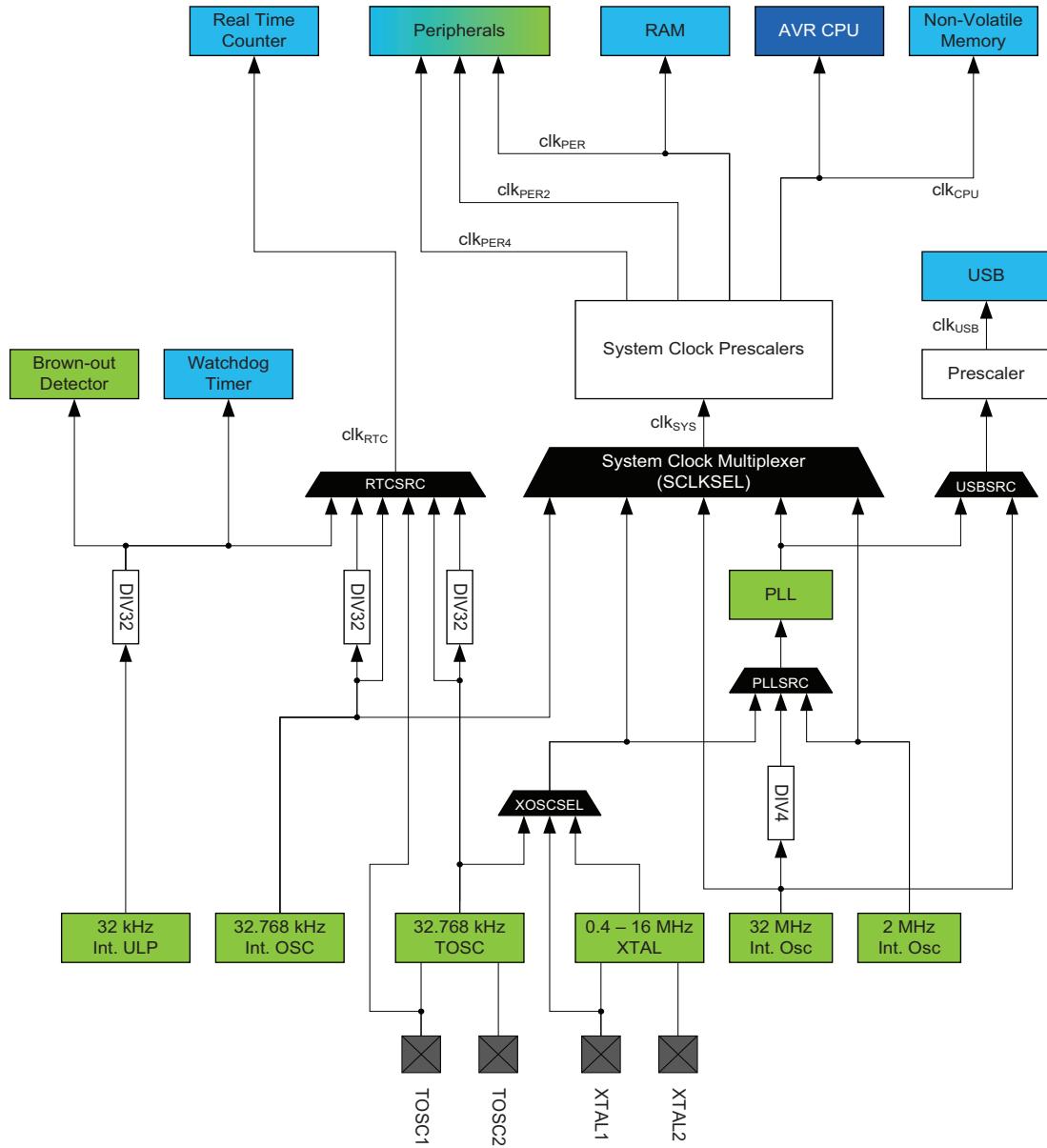
### 10.2 Overview

Atmel AVR XMEGA A4U devices have a flexible clock system supporting a large number of clock sources. It incorporates both accurate internal oscillators and external crystal oscillator and resonator support. A high-frequency phase locked loop (PLL) and clock prescalers can be used to generate a wide range of clock frequencies. A calibration feature (DFLL) is available, and can be used for automatic run-time calibration of the internal oscillators to remove frequency drift over voltage and temperature. An oscillator failure monitor can be enabled to issue a non-maskable interrupt and switch to the internal oscillator if the external oscillator or PLL fails.

When a reset occurs, all clock sources except the 32kHz ultra low power oscillator are disabled. After reset, the device will always start up running from the 2MHz internal oscillator. During normal operation, the system clock source and prescalers can be changed from software at any time.

[Figure 10-1 on page 22](#) presents the principal clock system in the XMEGA A4U family of devices. Not all of the clocks need to be active at a given time. The clocks for the CPU and peripherals can be stopped using sleep modes and power reduction registers, as described in [“Power Management and Sleep Modes” on page 24](#).

Figure 10-1. The clock system, clock sources and clock distribution.



## 10.3 Clock Sources

The clock sources are divided in two main groups: internal oscillators and external clock sources. Most of the clock sources can be directly enabled and disabled from software, while others are automatically enabled or disabled, depending on peripheral settings. After reset, the device starts up running from the 2MHz internal oscillator. The other clock sources, DFLLs and PLL, are turned off by default.

The internal oscillators do not require any external components to run. For details on characteristics and accuracy of the internal oscillators, refer to the device datasheet.

### 10.3.1 32kHz Ultra Low Power Internal Oscillator

This oscillator provides an approximate 32kHz clock. The 32kHz ultra low power (ULP) internal oscillator is a very low power clock source, and it is not designed for high accuracy. The oscillator employs a built-in prescaler that provides

## 19. Hi-Res – High Resolution Extension

### 19.1 Features

- Increases waveform generator resolution up to 8x (three bits)
- Supports frequency, single-slope PWM, and dual-slope PWM generation
- Supports the AWeX when this is used for the same timer/counter

### 19.2 Overview

The high-resolution (hi-res) extension can be used to increase the resolution of the waveform generation output from a timer/counter by four or eight. It can be used for a timer/counter doing frequency, single-slope PWM, or dual-slope PWM generation. It can also be used with the AWeX if this is used for the same timer/counter.

The hi-res extension uses the peripheral 4x clock ( $\text{Clk}_{\text{PER4}}$ ). The system clock prescalers must be configured so the peripheral 4x clock frequency is four times higher than the peripheral and CPU clock frequency when the hi-res extension is enabled.

There are three hi-res extensions that each can be enabled for each timer/counters pair on PORTC, PORTD and PORTE. The notation of these are HIRES<sub>C</sub>, HIRES<sub>D</sub> and HIRES<sub>E</sub>, respectively.

PORTC and PORTE each has one TWI. Notation of these peripherals are TWIC and TWIE.

## 23. SPI – Serial Peripheral Interface

### 23.1 Features

- Two Identical SPI peripherals
- Full-duplex, three-wire synchronous data transfer
- Master or slave operation
- Lsb first or msb first data transfer
- Eight programmable bit rates
- Interrupt flag at the end of transmission
- Write collision flag to indicate data collision
- Wake up from idle sleep mode
- Double speed master mode

### 23.2 Overview

The Serial Peripheral Interface (SPI) is a high-speed synchronous data transfer interface using three or four pins. It allows fast communication between an Atmel AVR XMEGA device and peripheral devices or between several microcontrollers. The SPI supports full-duplex communication.

A device connected to the bus must act as a master or slave. The master initiates and controls all data transactions. PORTC and PORTD each has one SPI. Notation of these peripherals are SPIC and SPID.

Mnemonic	Operands	Description	Operation	Flags	#Clocks
CLZ		Clear Zero Flag	$Z \leftarrow 0$	Z	1
SEI		Global Interrupt Enable	$I \leftarrow 1$	I	1
CLI		Global Interrupt Disable	$I \leftarrow 0$	I	1
SES		Set Signed Test Flag	$S \leftarrow 1$	S	1
CLS		Clear Signed Test Flag	$S \leftarrow 0$	S	1
SEV		Set Two's Complement Overflow	$V \leftarrow 1$	V	1
CLV		Clear Two's Complement Overflow	$V \leftarrow 0$	V	1
SET		Set T in SREG	$T \leftarrow 1$	T	1
CLT		Clear T in SREG	$T \leftarrow 0$	T	1
SEH		Set Half Carry Flag in SREG	$H \leftarrow 1$	H	1
CLH		Clear Half Carry Flag in SREG	$H \leftarrow 0$	H	1
MCU control instructions					
BREAK		Break	(See specific descr. for BREAK)	None	1
NOP		No Operation		None	1
SLEEP		Sleep	(see specific descr. for Sleep)	None	1
WDR		Watchdog Reset	(see specific descr. for WDR)	None	1

Notes:

1. Cycle times for Data memory accesses assume internal memory accesses, and are not valid for accesses via the external RAM interface.
2. One extra cycle must be added when accessing Internal SRAM.

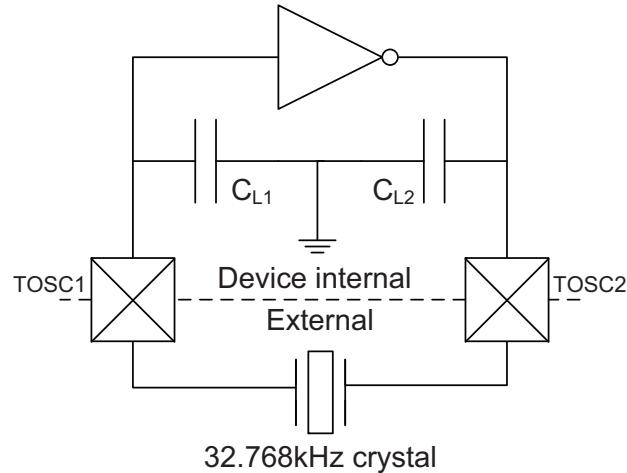
### 36.2.14.8 External 32.768kHz crystal oscillator and TOSC characteristics

Table 36-62. External 32.768kHz crystal oscillator and TOSC characteristics.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
ESR/R1	Recommended crystal equivalent series resistance (ESR)	Crystal load capacitance 6.5pF			60	kΩ
		Crystal load capacitance 9.0pF			35	
C <sub>TOSC1</sub>	Parasitic capacitance TOSC1 pin			5.4		pF
		Alternate TOSC location		4.0		
C <sub>TOSC2</sub>	Parasitic capacitance TOSC2 pin			7.1		pF
		Alternate TOSC location		4.0		
	Recommended safety factor	capacitance load matched to crystal specification	3.0			

Note: 1. See [Figure 36-11](#) for definition.

Figure 36-11.TOSC input capacitance.



The parasitic capacitance between the TOSC pins is  $C_{L1} + C_{L2}$  in series as seen from the crystal when oscillating without external capacitors.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
Offset error, input referred		1x gain, normal mode		-2		mV
		8x gain, normal mode		-5		
		64x gain, normal mode		-4		
Noise		1x gain, normal mode	$V_{CC} = 3.6V$ Ext. $V_{REF}$	0.5		mV rms
		8x gain, normal mode		1.5		
		64x gain, normal mode		11		

Note: 1. Maximum numbers are based on characterisation and not tested in production, and valid for 5% to 95% input voltage range.

### 36.3.7 DAC Characteristics

Table 36-76. Power supply, reference and output range.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
$AV_{CC}$	Analog supply voltage		$V_{CC} - 0.3$		$V_{CC} + 0.3$	V
$AV_{REF}$	External reference voltage		1.0		$V_{CC} - 0.6$	V
$R_{channel}$	DC output impedance				50	$\Omega$
	Linear output voltage range		0.15		$AV_{CC} - 0.15$	V
$R_{AREF}$	Reference input resistance			>10		$M\Omega$
CAREF	Reference input capacitance	Static load		7		pF
	Minimum resistance load		1.0			k $\Omega$
	Maximum capacitance load				100	pF
		1000 $\Omega$ serial resistance			1.0	nF
	Output sink/source	Operating within accuracy specification			$AV_{CC}/1000$	mA
		Safe operation			10	

Table 36-77. Clock and timing.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
$f_{DAC}$	Conversion rate	$C_{load}=100pF$ , maximum step size	Normal mode	0	1000	ksps
			Low power mode		500	

### 36.3.14 Clock and Oscillator Characteristics

#### 36.3.14.1 Calibrated 32.768kHz Internal Oscillator characteristics

**Table 36-86. 32.768kHz internal oscillator characteristics.**

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
	Frequency			32.768		kHz
	Factory calibration accuracy	T = 85°C, V <sub>CC</sub> = 3.0V	-0.5		0.5	%
	User calibration accuracy		-0.5		0.5	%

#### 36.3.14.2 Calibrated 2MHz RC Internal Oscillator characteristics

**Table 36-87. 2MHz internal oscillator characteristics.**

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
	Frequency range	DFLL can tune to this frequency over voltage and temperature	1.8		2.2	MHz
	Factory calibrated frequency			2.0		MHz
	Factory calibration accuracy	T = 85°C, V <sub>CC</sub> = 3.0V	-1.5		1.5	%
	User calibration accuracy		-0.2		0.2	%
	DFLL calibration stepsize			0.21		%

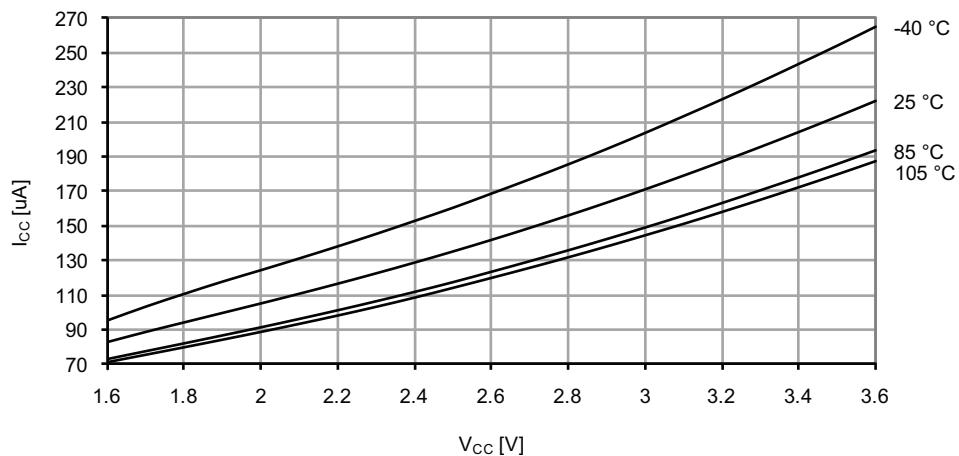
#### 36.3.14.3 Calibrated and tunable 32MHz internal oscillator characteristics

**Table 36-88. 32MHz internal oscillator characteristics.**

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
	Frequency range	DFLL can tune to this frequency over voltage and temperature	30		55	MHz
	Factory calibrated frequency			32		MHz
	Factory calibration accuracy	T = 85°C, V <sub>CC</sub> = 3.0V	-1.5		1.5	%
	User calibration accuracy		-0.2		0.2	%
	DFLL calibration step size			0.22		%

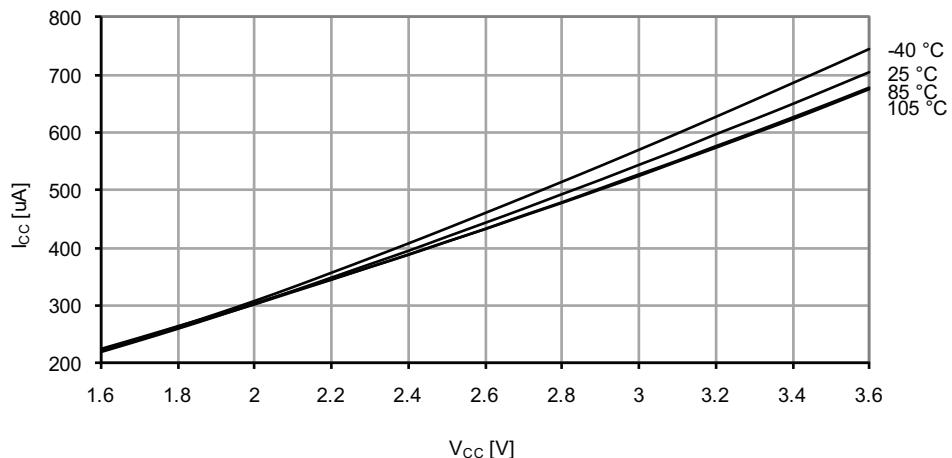
**Figure 37-3. Active mode supply current vs. V<sub>CC</sub>.**

$f_{SYS} = 32.768\text{kHz}$  internal oscillator.

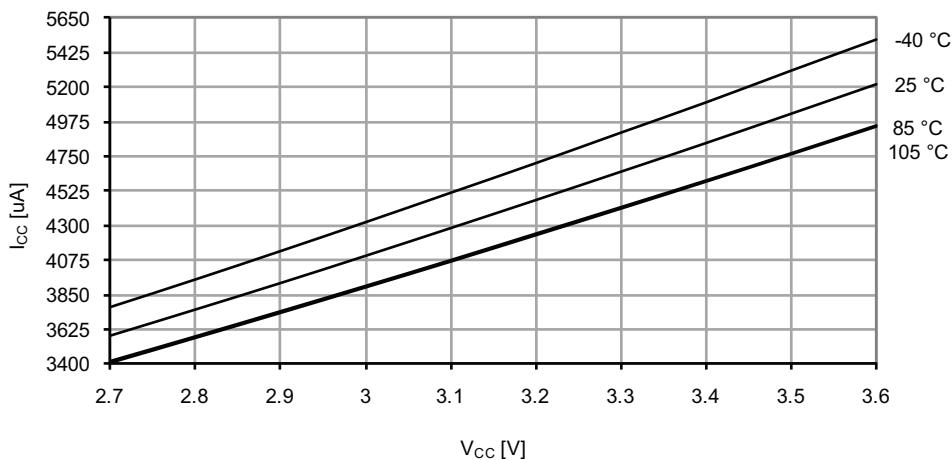


**Figure 37-4. Active mode supply current vs. V<sub>CC</sub>.**

$f_{SYS} = 1\text{MHz}$  external clock.

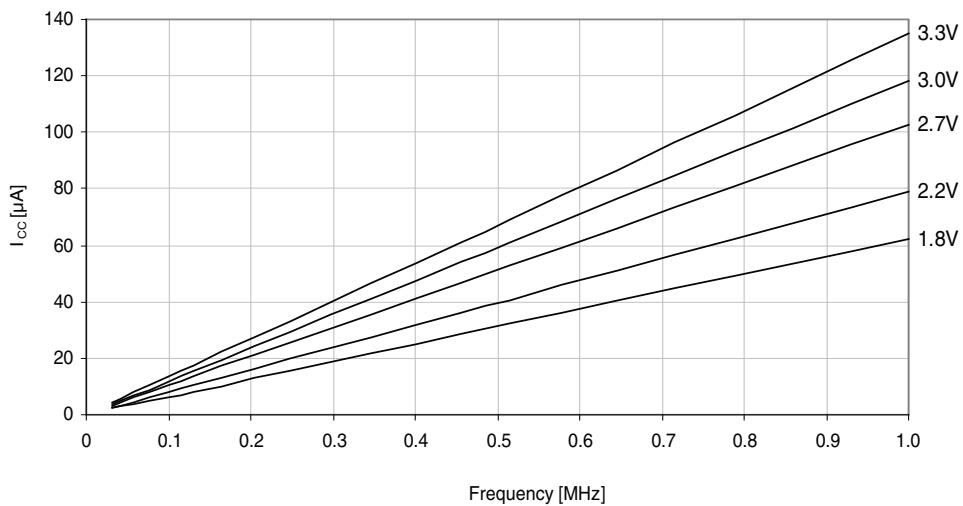


**Figure 37-7. Active mode supply current vs.  $V_{CC}$ .**  
 $f_{SYS} = 32\text{MHz}$  internal oscillator.



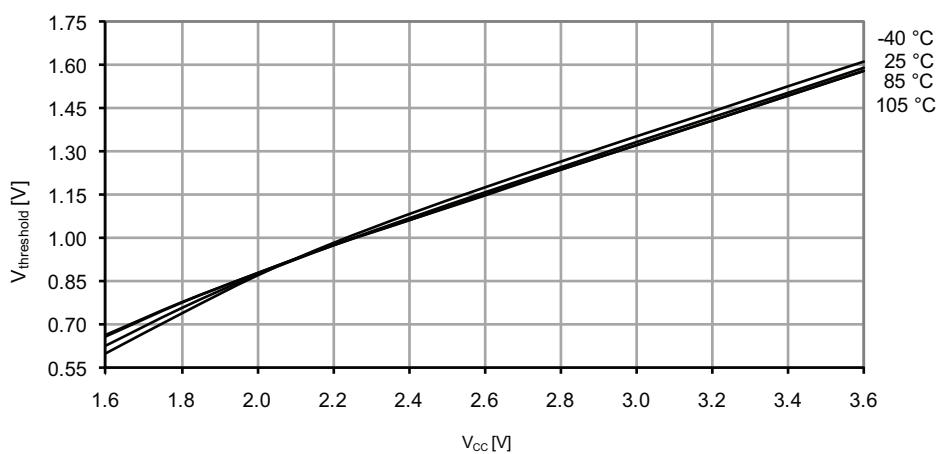
### 37.1.1.2 Idle mode supply current

**Figure 37-8. Idle mode supply current vs. frequency.**  
 $f_{SYS} = 0 - 1\text{MHz}$  external clock,  $T = 25^\circ\text{C}$ .

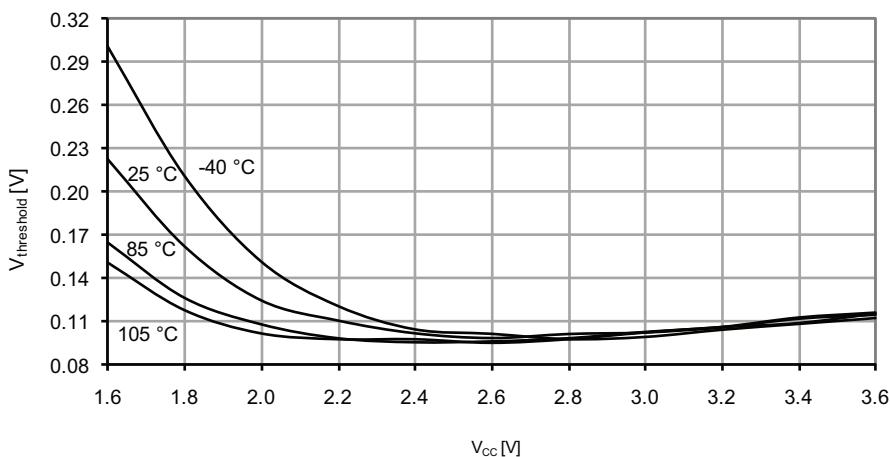


**Figure 37-34. I/O pin input threshold voltage vs.  $V_{CC}$ .**

$V_{IL}$  I/O pin read as “0”.

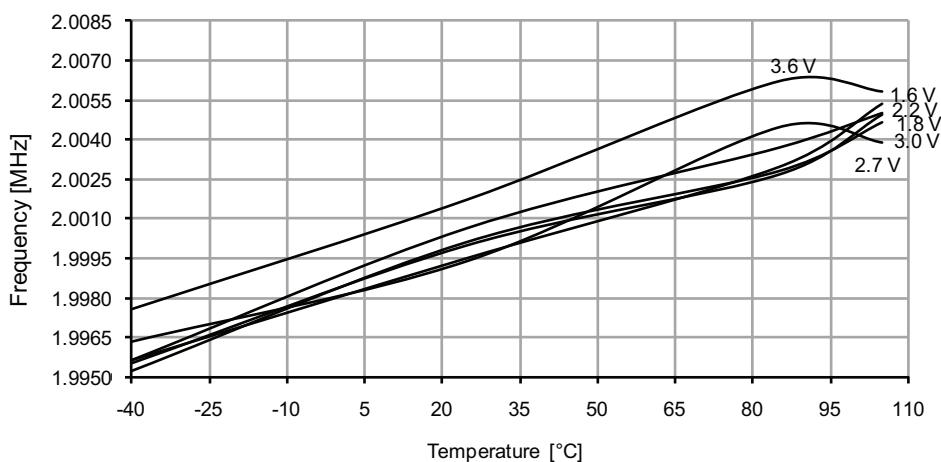


**Figure 37-35. I/O pin input hysteresis vs.  $V_{CC}$ .**



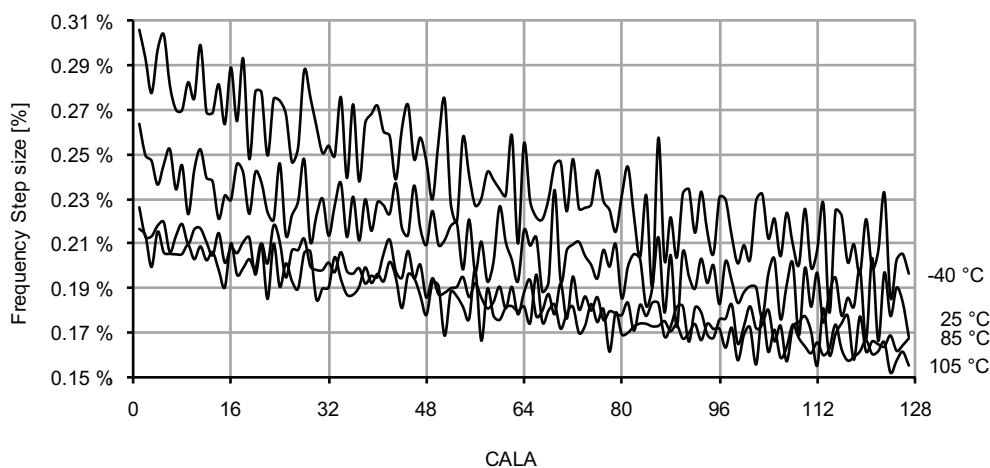
**Figure 37-74. 2MHz internal oscillator frequency vs. temperature.**

*DFLL enabled, from the 32.768kHz internal oscillator .*



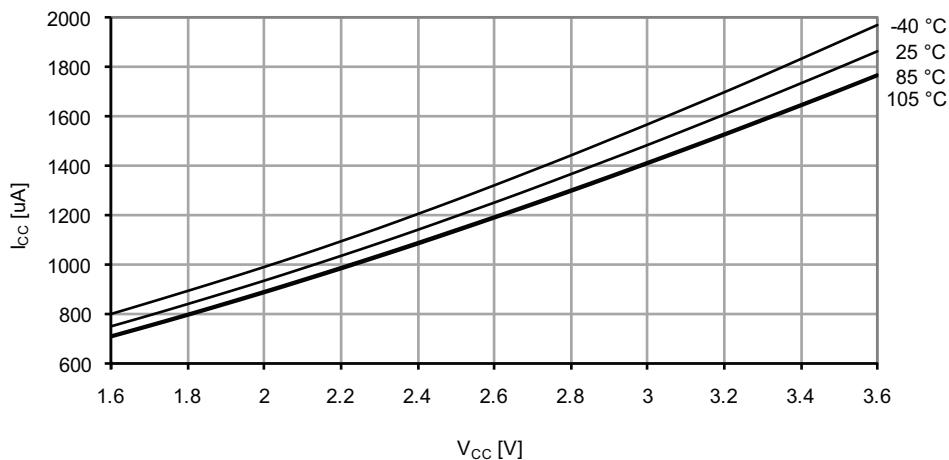
**Figure 37-75. 2MHz internal oscillator CALA calibration step size.**

$V_{CC} = 3V$ .



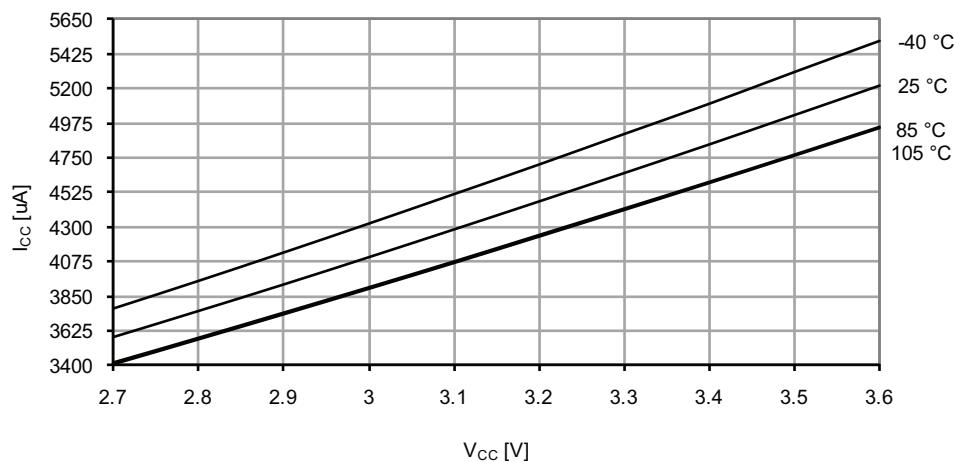
**Figure 37-97. Idle mode supply current vs.  $V_{CC}$ .**

$f_{SYS} = 32\text{MHz}$  internal oscillator prescaled to 8MHz.



**Figure 37-98. Idle mode current vs.  $V_{CC}$ .**

$f_{SYS} = 32\text{MHz}$  internal oscillator.



### 37.2.10.5 32MHz internal oscillator calibrated to 48MHz

Figure 37-164. 48MHz internal oscillator frequency vs. temperature.

*DFLL disabled.*

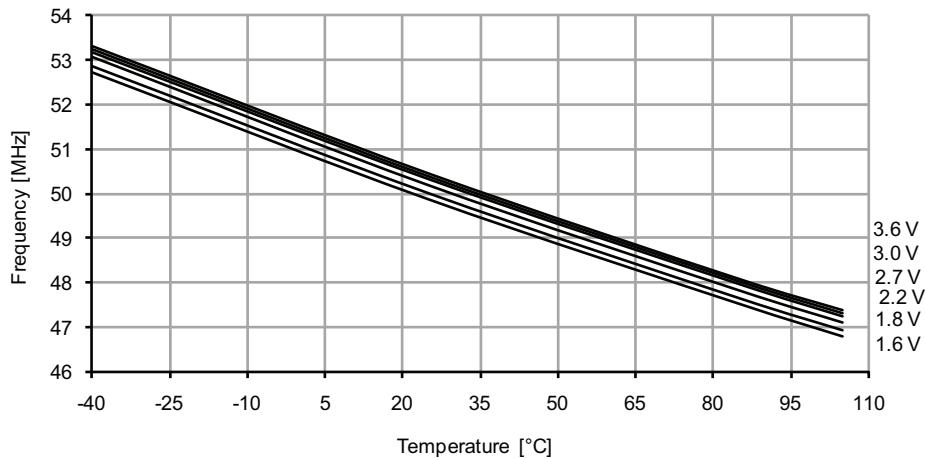
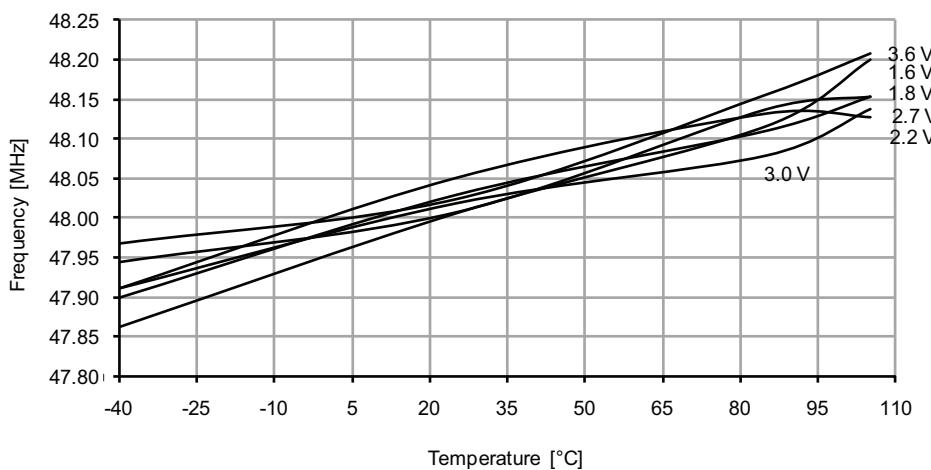


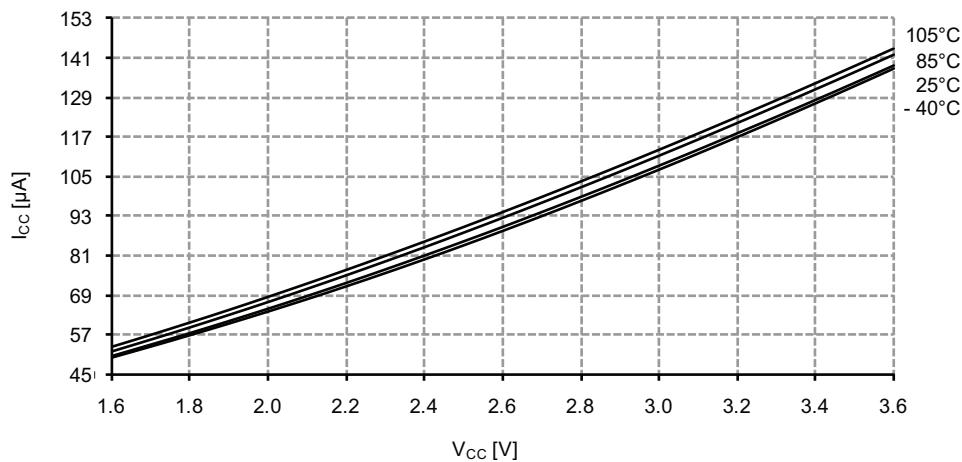
Figure 37-165. 48MHz internal oscillator frequency vs. temperature.

*DFLL enabled, from the 32.768kHz internal oscillator.*



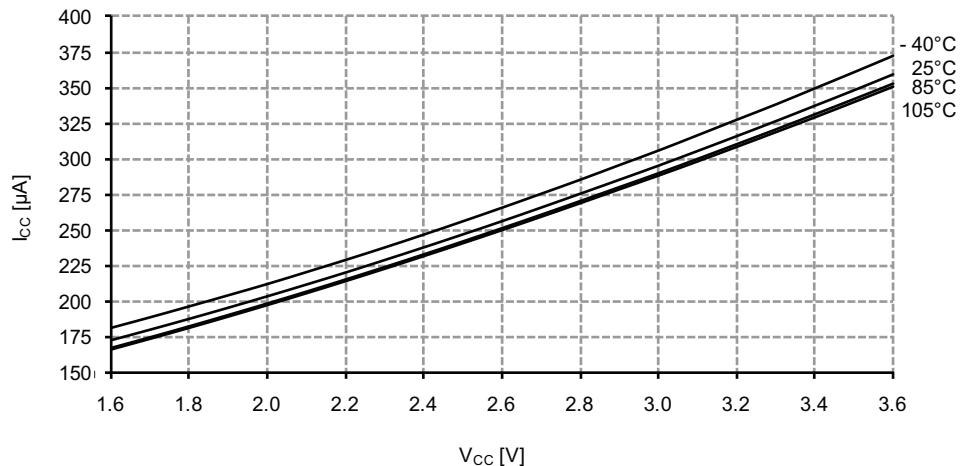
**Figure 37-179. Idle mode supply current vs.  $V_{CC}$ .**

$f_{SYS} = 1\text{MHz}$  external clock.



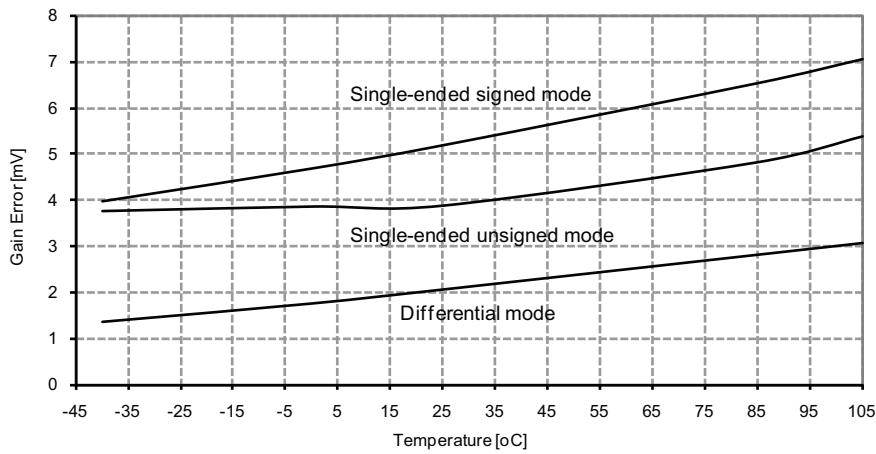
**Figure 37-180. Idle mode supply current vs.  $V_{CC}$ .**

$f_{SYS} = 2\text{MHz}$  internal oscillator.



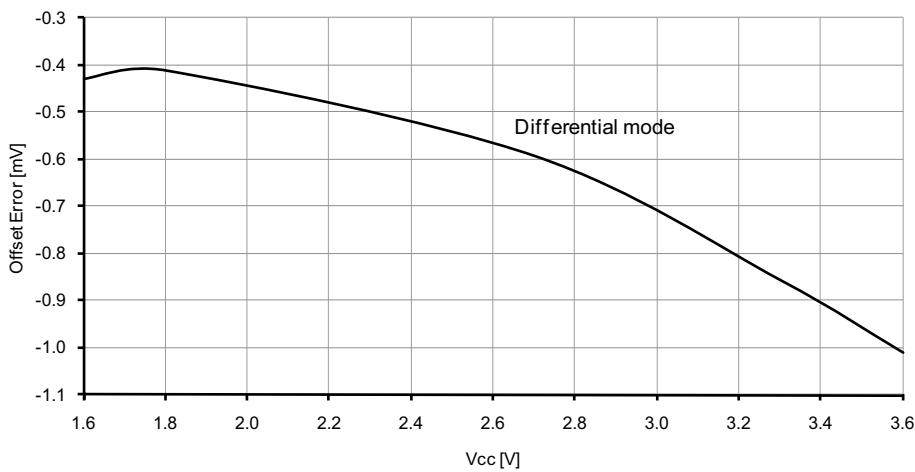
**Figure 37-213. Gain error vs. temperature.**

$V_{CC} = 2.7V$ ,  $V_{REF} = \text{external } 1.0V$ .

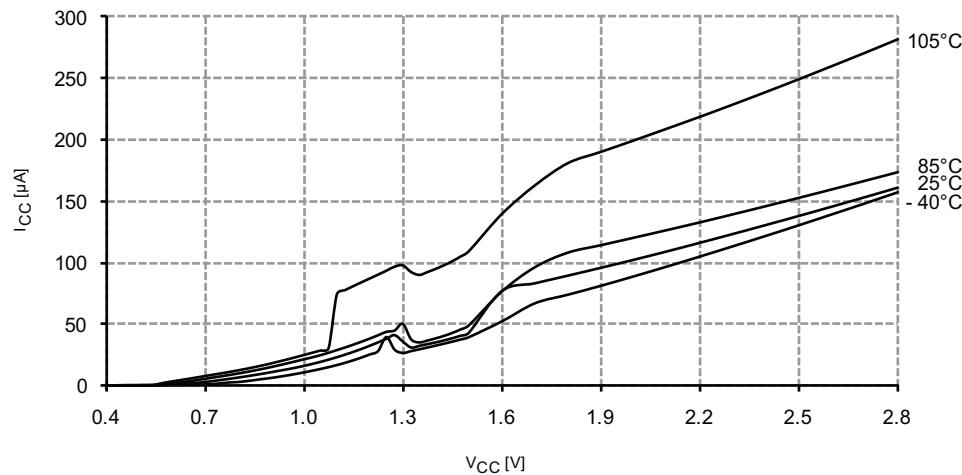


**Figure 37-214. Offset error vs.  $V_{CC}$ .**

$T = 25^\circ\text{C}$ ,  $V_{REF} = \text{external } 1.0V$ , ADC sampling speed = 500ksps.



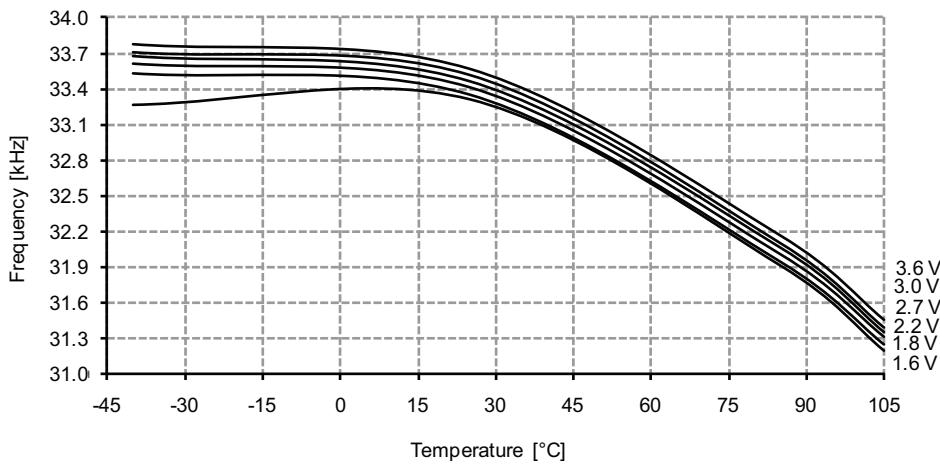
**Figure 37-237. Power-on reset current consumption vs.  $V_{CC}$ .**  
*BOD level = 3.0V, enabled in sampled mode.*



### 37.3.10 Oscillator Characteristics

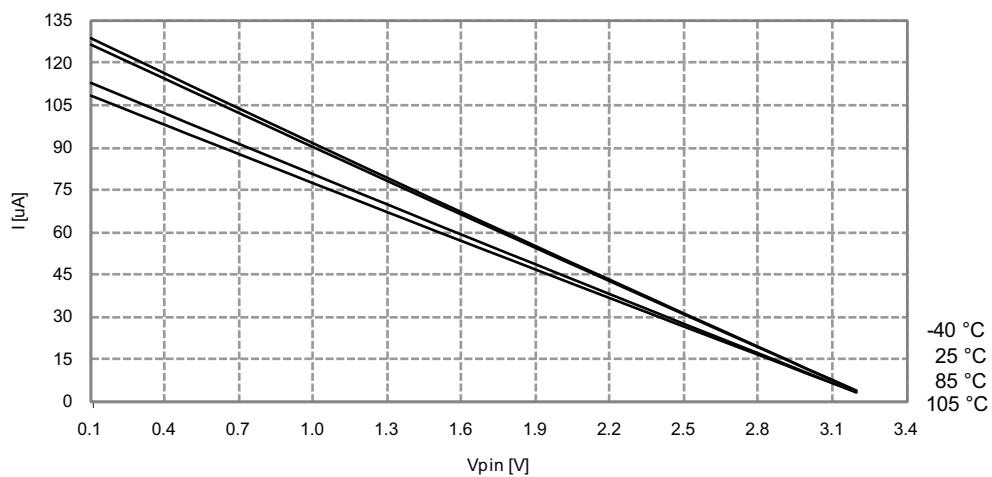
#### 37.3.10.1 Ultra Low-Power internal oscillator

**Figure 37-238. Ultra Low-Power internal oscillator frequency vs. temperature.**



**Figure 37-275. I/O pin pull-up resistor current vs. input voltage.**

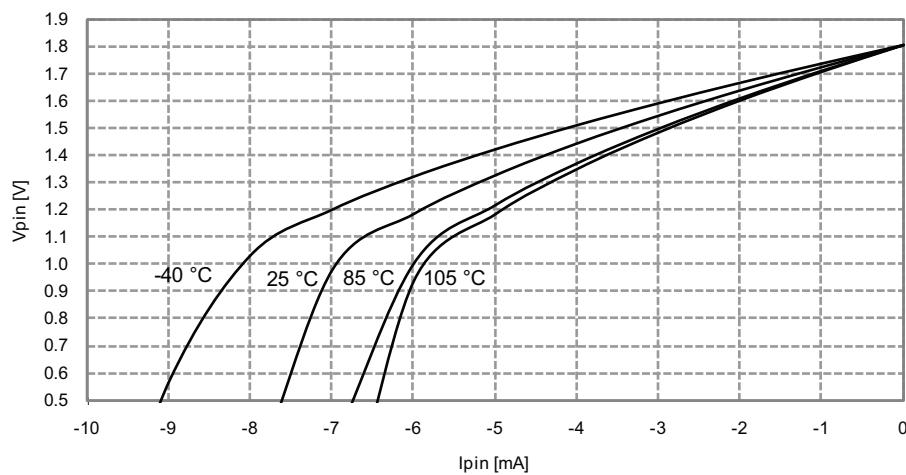
$V_{CC} = 3.3V$ .



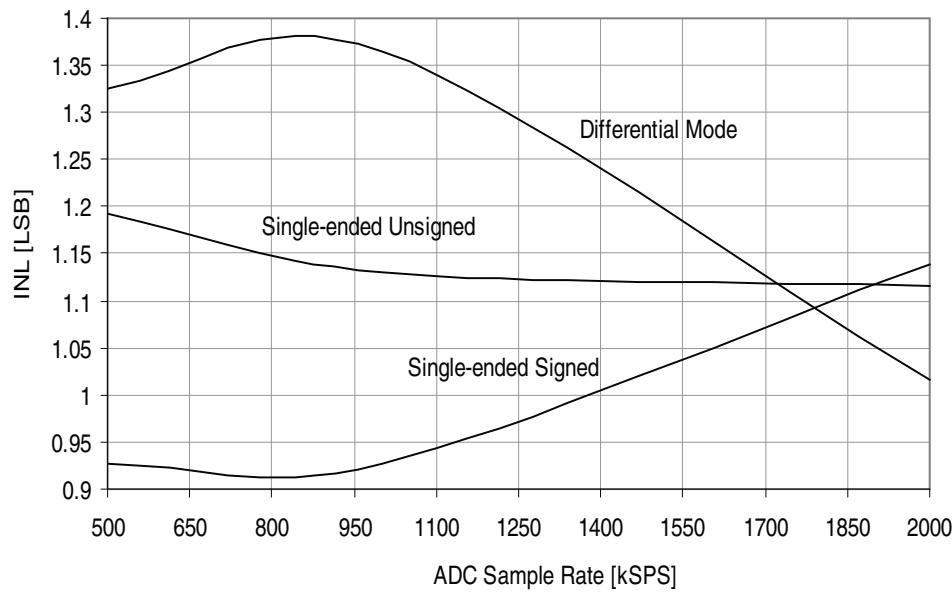
#### 37.4.2.2 Output Voltage vs. Sink/Source Current

**Figure 37-276. I/O pin output voltage vs. source current.**

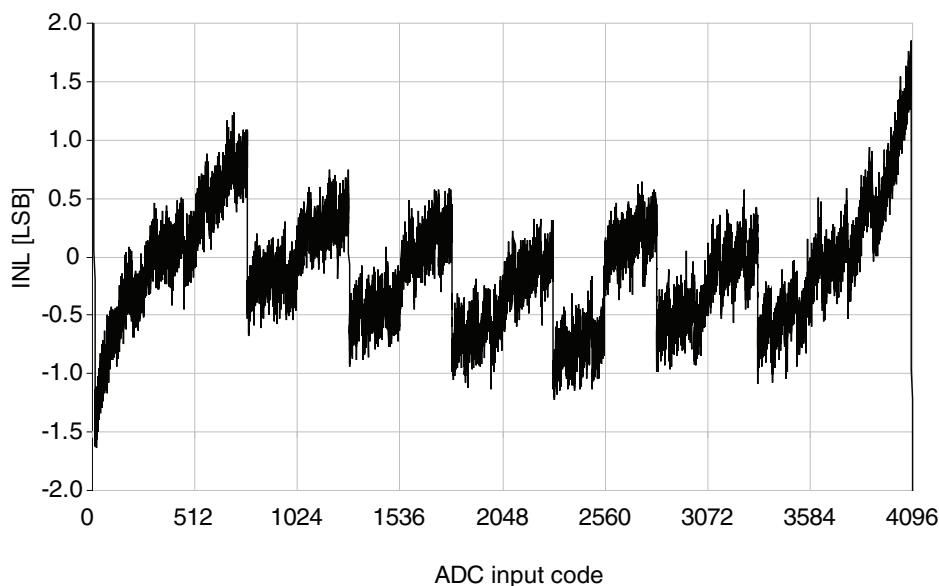
$V_{CC} = 1.8V$



**Figure 37-289. INL error vs. sample rate**  
 $T = 25^\circ\text{C}$ ,  $V_{CC} = 3.6\text{V}$ ,  $V_{REF} = 3.0\text{V}$  external



**Figure 37-290. INL error vs. input code**



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